



Product Data Sheet & General Processing Conditions

RTPRENE® M 40D BK Thermoplastic Vulcanizate (TPV) Extrusion Grade UV Stabilized

PROPERTIES & AVERAGE VALUES OF INJECTION MOLDED SPECIMENS

PERMANENCE		STANDARD
Density	0.94 g/cm ³	ISO 1183
MECHANICAL		
Tensile Strength Break	20 MPa	ISO 37
Tensile Elongation Break	700.0 %	ISO 37
Tensile Stress @ 100 %	9.5 MPa	ISO 37
Tear Strength, Method B, Procedure A	77.0 N/mm	ISO 34-1
Hardness Shore D, 15 s delay	41	ISO 868

PROPERTY NOTES

Data herein is typical and not to be construed as specifications.
Unless otherwise specified, all data listed is for natural or black colored materials. Pigments can affect properties.

GENERAL PROCESSING FOR EXTRUSION PROCESSING

Melt Temperature	180 - 210 °C
Drying	2 - 4 hrs @ 80 °C
Moisture Content	< 0.05 %
Dew Point	< -18 °C

PROCESSING NOTES

Desiccant Type Dryer Required.

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This information is intended to be used only as a guideline for designers and processors of modified thermoplastics. Because design and processing is complex, a set solution will not solve all problems. Observation on a "trial and error" basis may be required to achieve desired results.

Data are obtained from specimens molded under carefully controlled conditions from representative samples of the compound described herein. Properties may be materially affected by molding techniques applied and by the size and shape of the item molded. No assurance can be implied that all molded articles will have the same properties as those listed.

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